
Systems Engineering and Management for Robotics:

Printed Circuit Board Design and Fabrication

Questions to Answer

- **What is a Printed Circuit Board (PCB) and why are they instrumental to electronic devices?**
- **How do I design a PCB?**
 - What's an electrical schematic good for?
 - What's a “Layout”?
 - Where do parts come from?
- **How do I convert a system diagram into an electrical schematic?**
- **What are some important design considerations?**

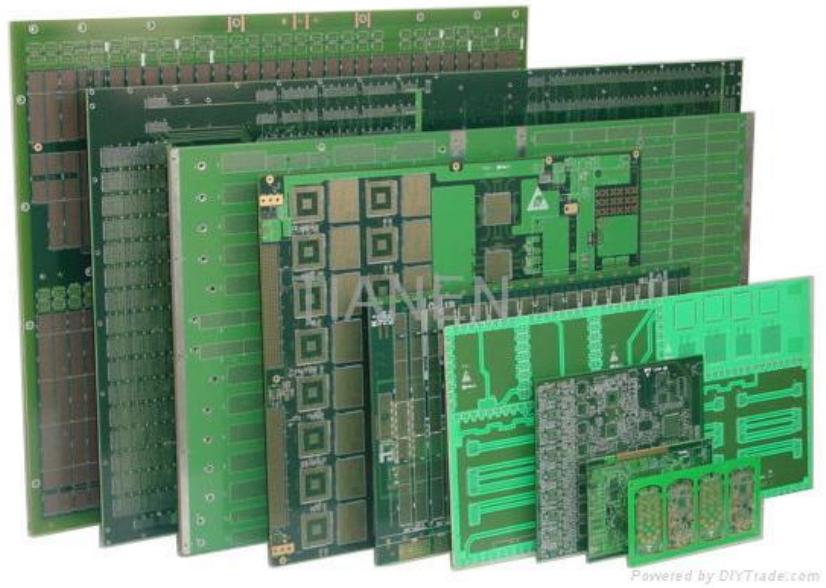
Who is this man?

- Paul Eisler (1907-1995)
- Invented the PCB in 1936
- Used it in his radio
 - Also used in proximity fuse
- Also invented...
 - Rear-window defroster
 - Pizza warmer



The Printed Circuit Board (PCB)

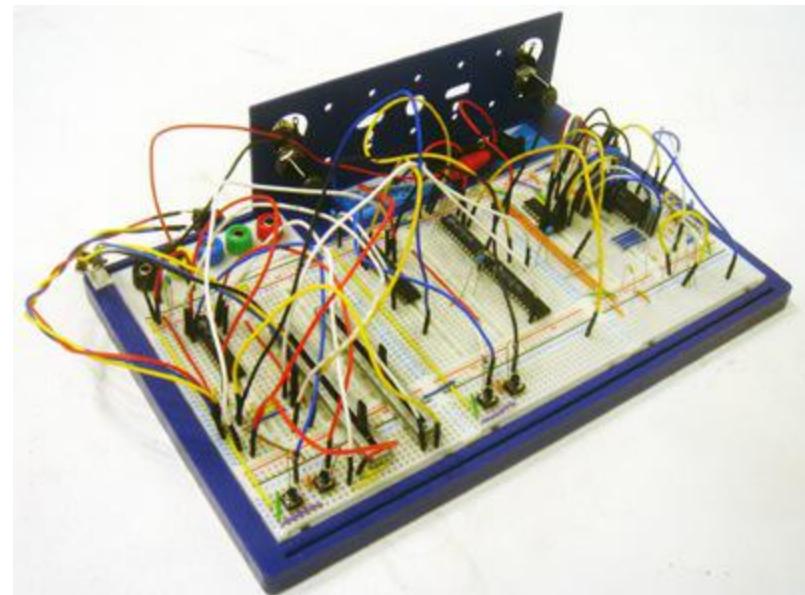
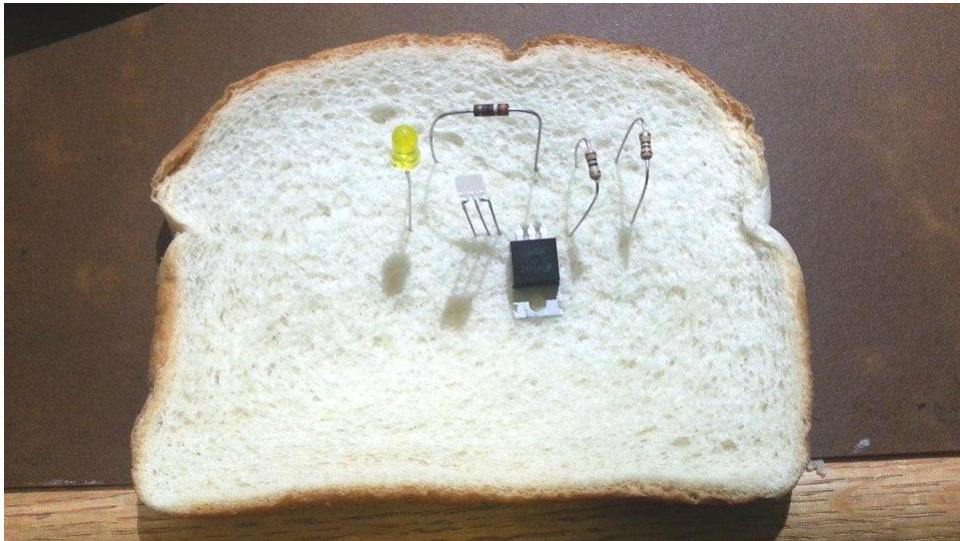
- **Essential Component**
- **Mechanical Mounting**
- **Electrical Connectivity**
 - Traces can also form components
- **Many flavors**
 - Color, flexibility, temperature rating, density



Powered by DIYTrade.com

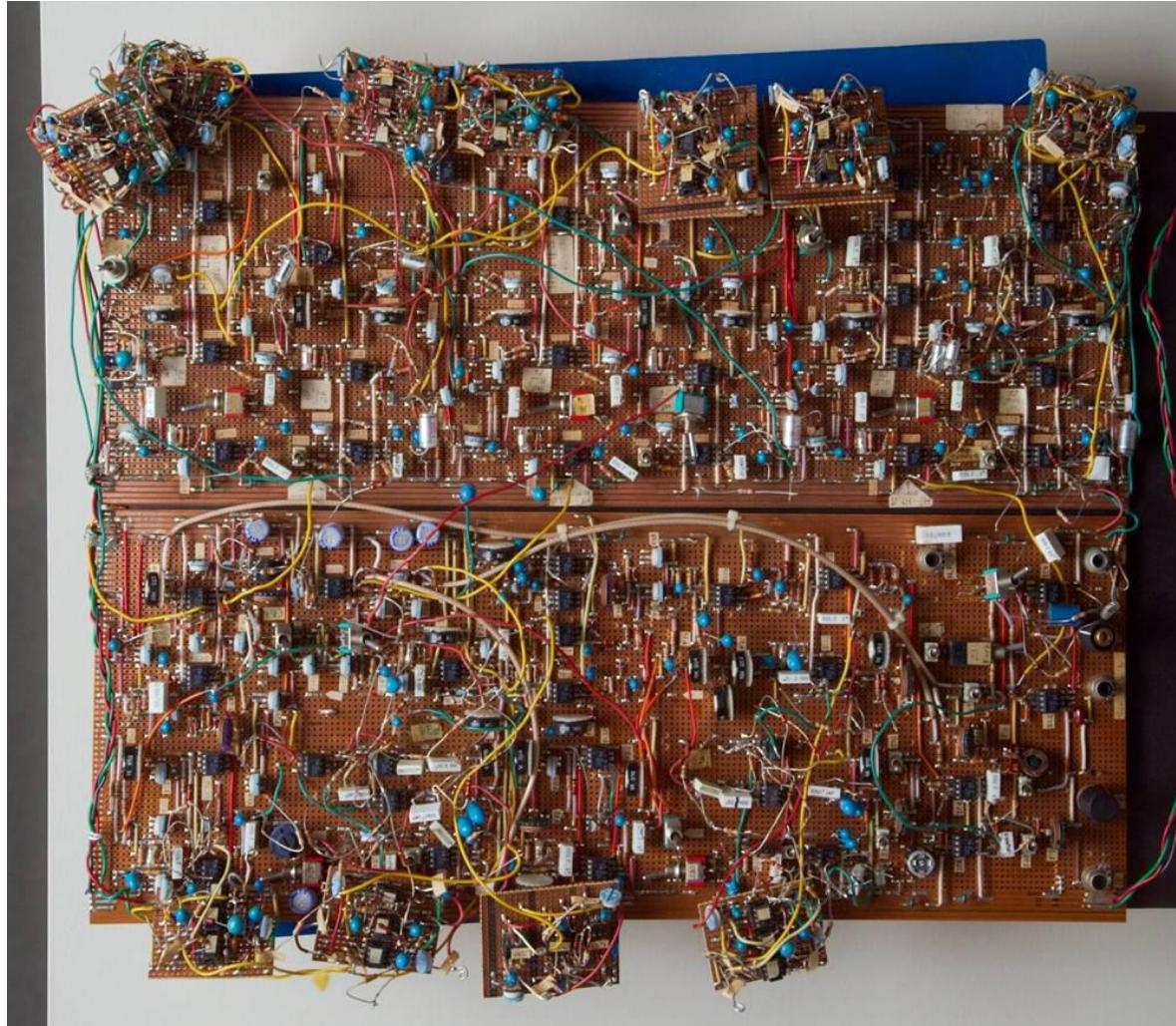
Which is Better?

This???

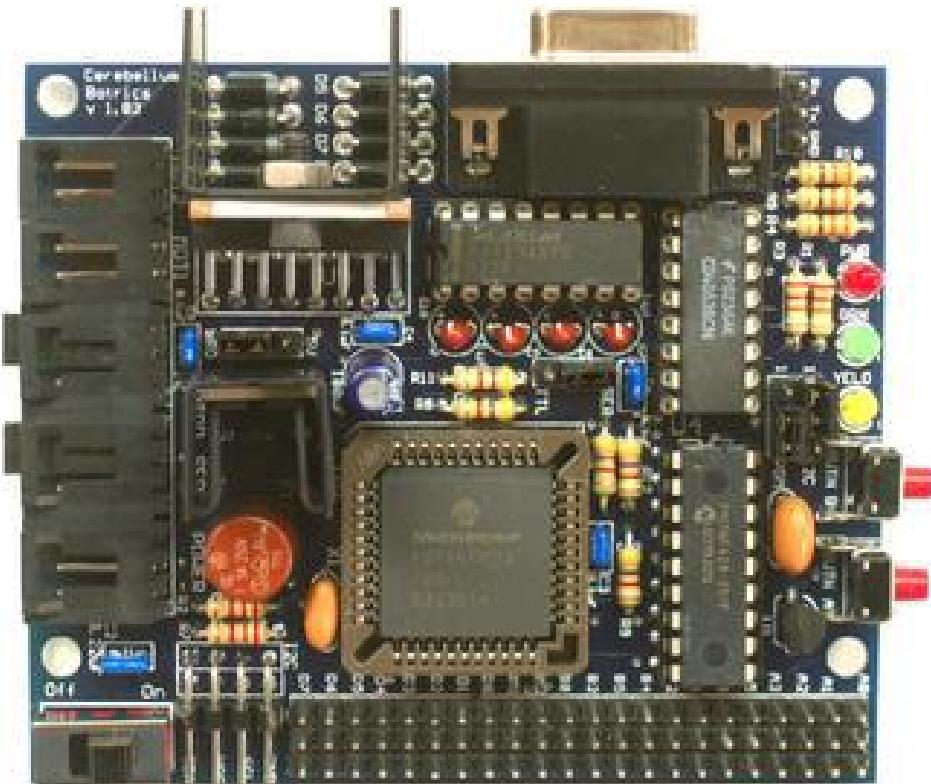


Which is Better?

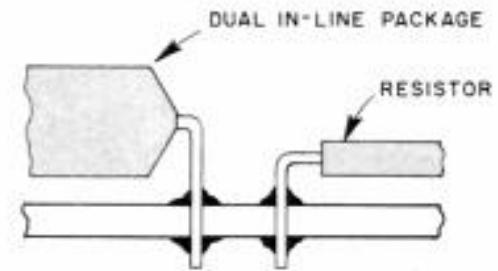
This???!!!?!!



This is Better



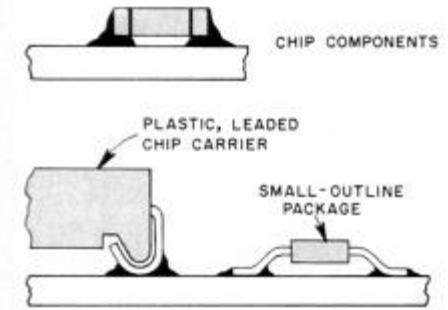
Through-hole



This is Even Better *



Surface mount

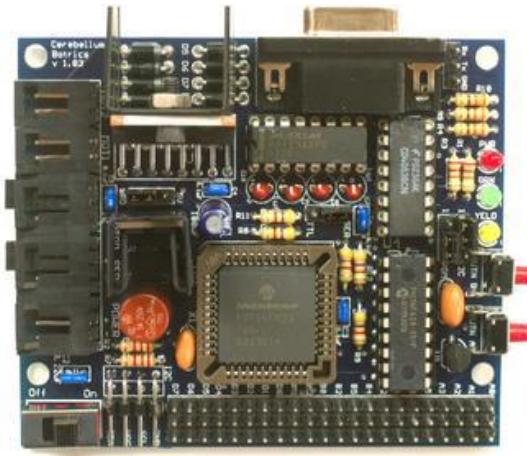


* see next slide

Through-Hole Vs. Surface Mount

Through-Hole:

- Easy to solder
- Easier to fix circuits
- You don't lose components on the floor



Surface Mount:

- Miniaturization
 - From *small* to *ridiculous*
- Easier Automated Assembly
- PCB Fabrication is easier
 - fewer holes to drill
 - shorter manufacturing time
- Most cool/advanced parts are only Surface Mount



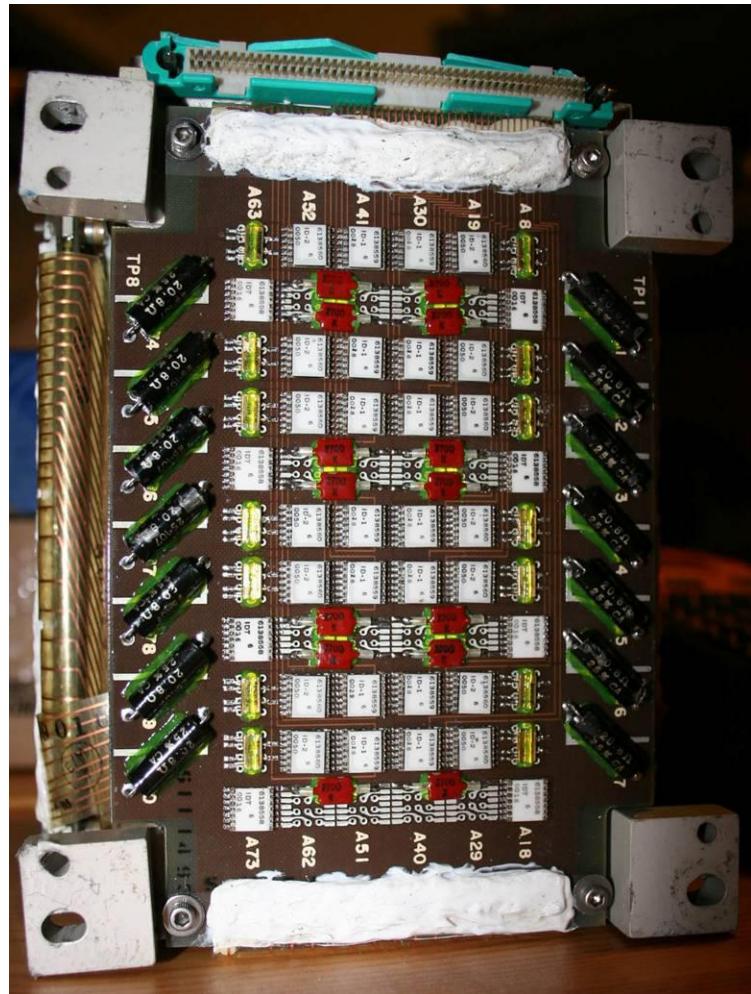
Another Historical Digression

- First *surface mount boards* were developed for Saturn V flight computers

- In 1964
- By IBM

- This module can hold 14,336 bytes

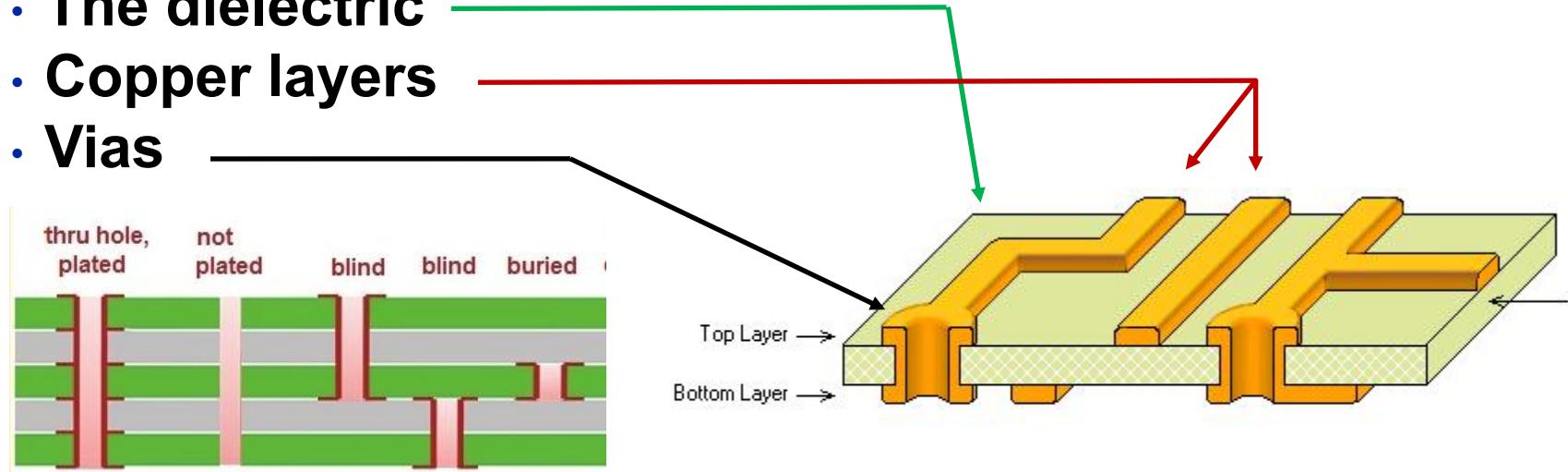
- The Saturn V had 8 of them



Multi-layer Construction

- PCBs have many layers:

- The dielectric
- Copper layers
- Vias



- Other Common Features

- **Soldermask:** [usually green] overlay that insulates copper
- **Silkscreen:** [usually white] with text, logos, etc.
- **Multi-layer:** Many sandwiched copper/dielectric layers
“planes” are often implemented this way. Complex PCBs like motherboards might have 16 copper layers—or even more

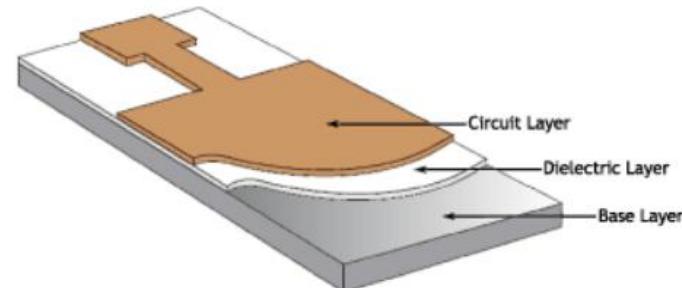
PCB Materials

- PCBs are available in several grades

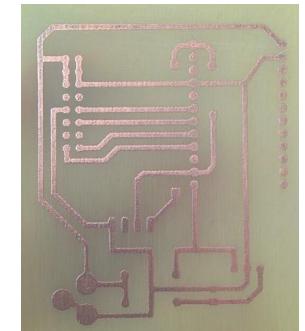
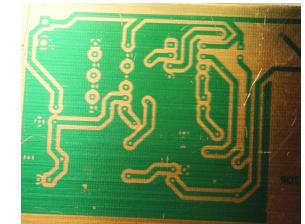
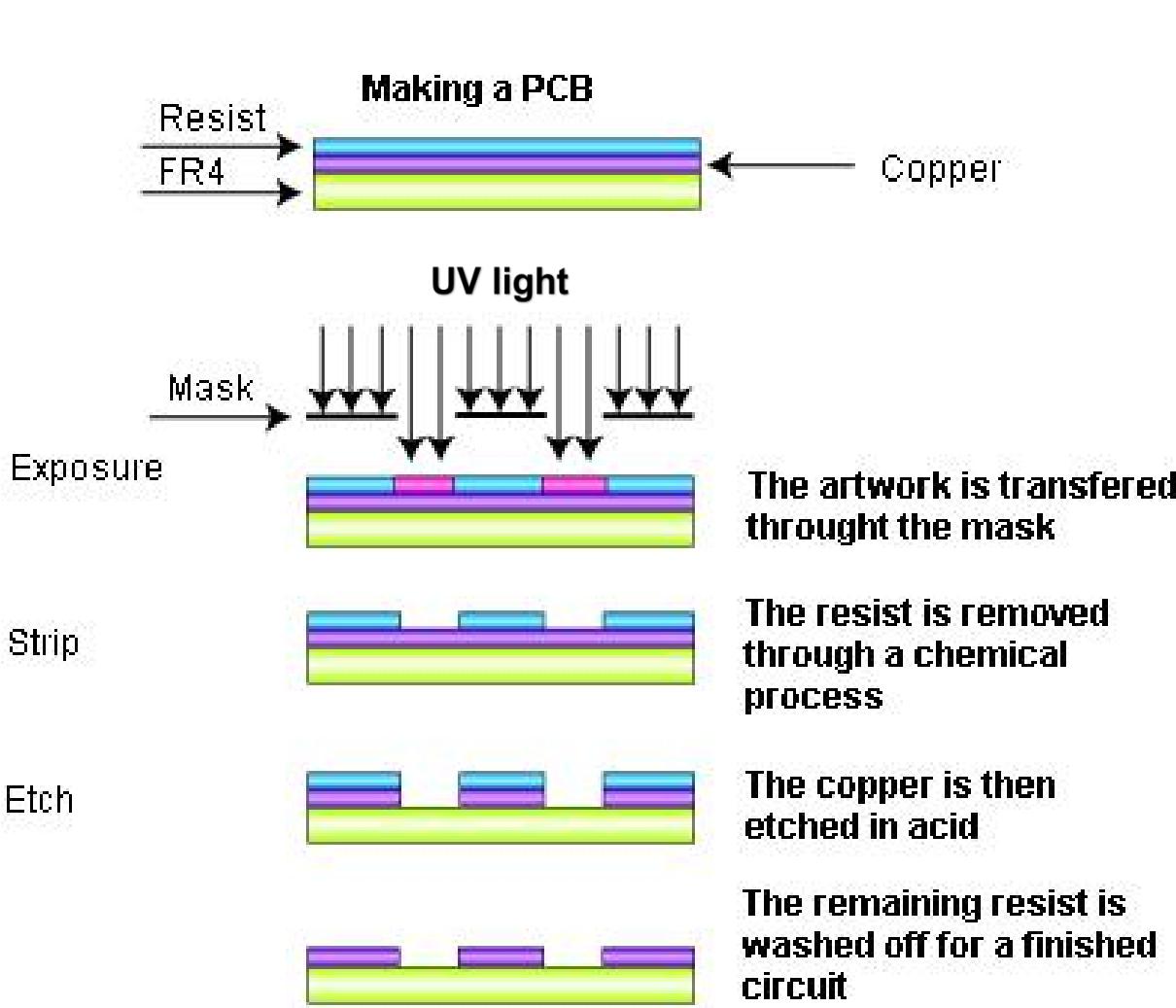
GRADE DESIGNATION	MATERIAL/COMMENTS
FR-1	Paper/phenolic: room temperature punchable, poor moisture resistance.
FR-2	Paper/phenolic: suitable for single-sided PCB consumer equipment, good moisture resistance.
FR-3	Paper/epoxy: designed for balance of good mechanical and electrical characteristics.
FR-4	Glass cloth/epoxy: excellent mechanical and electrical properties.
FR-5	Glass cloth/epoxy: high strength at elevated temperatures, self-extinguishing.
G10	Glass cloth/epoxy: high insulation resistance, highest bond strength of glass laminates, high humidity resistance.
G11	Glass cloth/epoxy: high flexural strength retention at high temperature, extreme resistance to solvents.

Aluminum PCB

- Higher heat transfer
- More expensive than FR-4
- Widely used in LED industry



Modern PCB Fabrication



Implementing Systems with PCBs

- **PCBs are a good way to implement *Interconnect***
 - Mechanical Mounting
 - Electrical Connectivity
- **Many parts are designed to operate solely on PCBs**
 - ICs (microcontrollers, regulators, motion controllers, modern sensors, etc.)
 - Discrete components shaped to fit
- **Standalone devices interact with PCBs via electrical connectors**
 - *Never underestimate the power of connectors to foil your project*

Custom PCBs in System Design: Benefits

- **Interconnect organization**

- Put all your electronic subsystems **in one place**
 - **Combine** many “breakout boards” into single PCB
 - **Eliminate** unnecessary electrical connectors
 - **Increase** reliability

- **Form Factor**

- Extreme miniaturization is possible
- PCB shape and part placement is definable
- Can fit very small or unusual shapes

- **Greater choice in component selection**

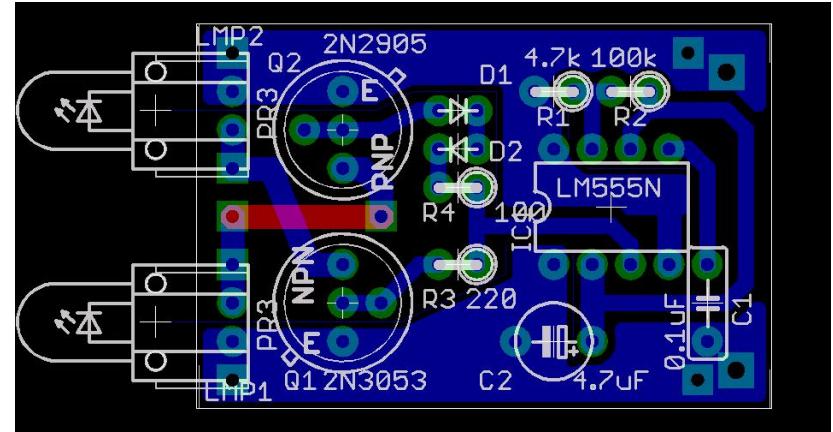
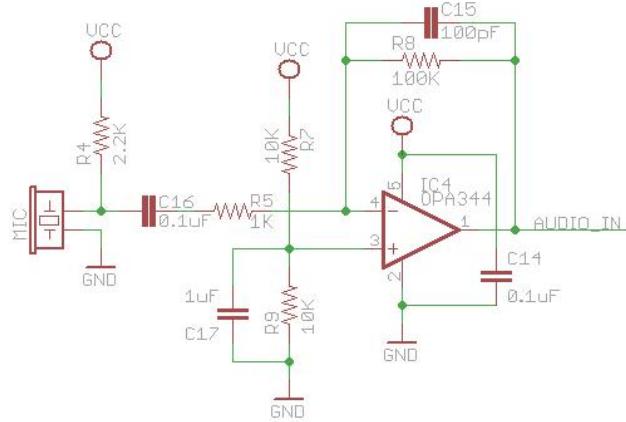
- Most modern parts not designed for standalone use
- Not limited to breakout boards, dev kits, or hobby parts
- Some electrical designs (high speed or analog) not possible or reliable using breadboards and development kits

Custom PCBs in System Design: **Drawbacks**

- **Learning Curve**
 - Takes a little more time to implement than COTS
 - Requires knowledge of electronics to implement
 - May require more testing/validation
 - Iterating PCB design 2-3 times (or more) is not uncommon
- **Failure may be harder to mitigate if entire system is on a single PCB!**
 - Can add additional, optional connectors to salvage
 - Test complex subsystems beforehand if possible
- **Balancing cost/effort against a COTS system**
 - For small design houses, turnaround on a design is generally 1-2 weeks
 - More effort in design, less effort in assembly / wiring
 - A single custom PCB may end up cheaper than 5 breakout boards

Designing PCBs with CAD tools:

Schematic Capture and Layout Design



PCB Design Software

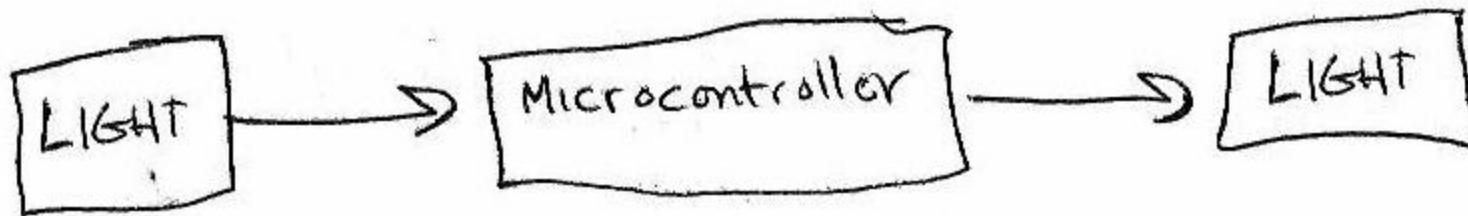
- **PCB CAD provides two separate (but linked) tools:**
 - **Schematic** capture / verification
 - **Layout** artwork / verification
- **Also provides ability to create parts libraries**
 - Basic building block links logical (schematic) diagrams to physical (layout) parts
- **Some common software packages:**
 - Eagle (Easily Accessible Graphical Layout Editor)
 - OrCAD
 - Altium CircuitMaker
 - PADs
 - Many others!

Eagle CAD

- **In this class we'll be using EagleCAD**
 - Available from
<https://www.autodesk.com/products/eagle/free-download>
 - Used by many—including Arduino designers
 - Commercial software
 - “free” version for non-commercial use
 - “free” restricted: 2-layer, 100mm x 80mm size
- **Also worth considering:**
 - *DIPTRACE*, available from <http://www.diptrace.com> at
 - Free, restricted version is also available
 - *KiCad EDA*, from <http://kicad-pcb.org>
 - *Altium CircuitMaker* <http://circuitmaker.com/>
 - MRSD Wiki: <http://cmumrsdproject.wikispaces.com/Altium+Circuitmaker>

Schematics: A Picture is Worth a Thousand Words

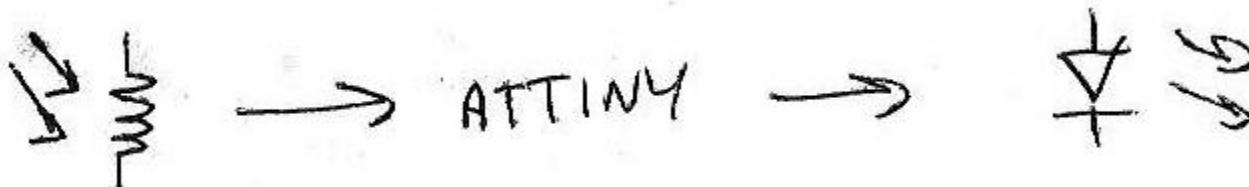
- Schematics represent circuits graphically
- Consider one very basic system:



- A little vague, but still a schematic
- A good schematic shows *what and how*

Adding Detail with Symbols

- Using specific symbols tells more information



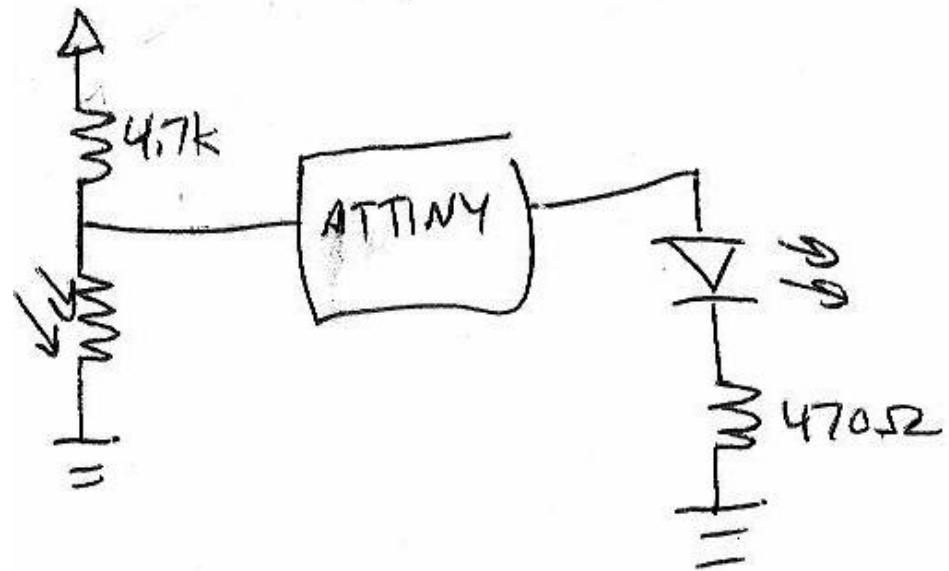
A photocell is read by an ATTiny microcontroller which lights an LED

- Shows you've thought about **what you're using**
- But → is not really a valid electrical device

Adding Detail with Basic Circuits

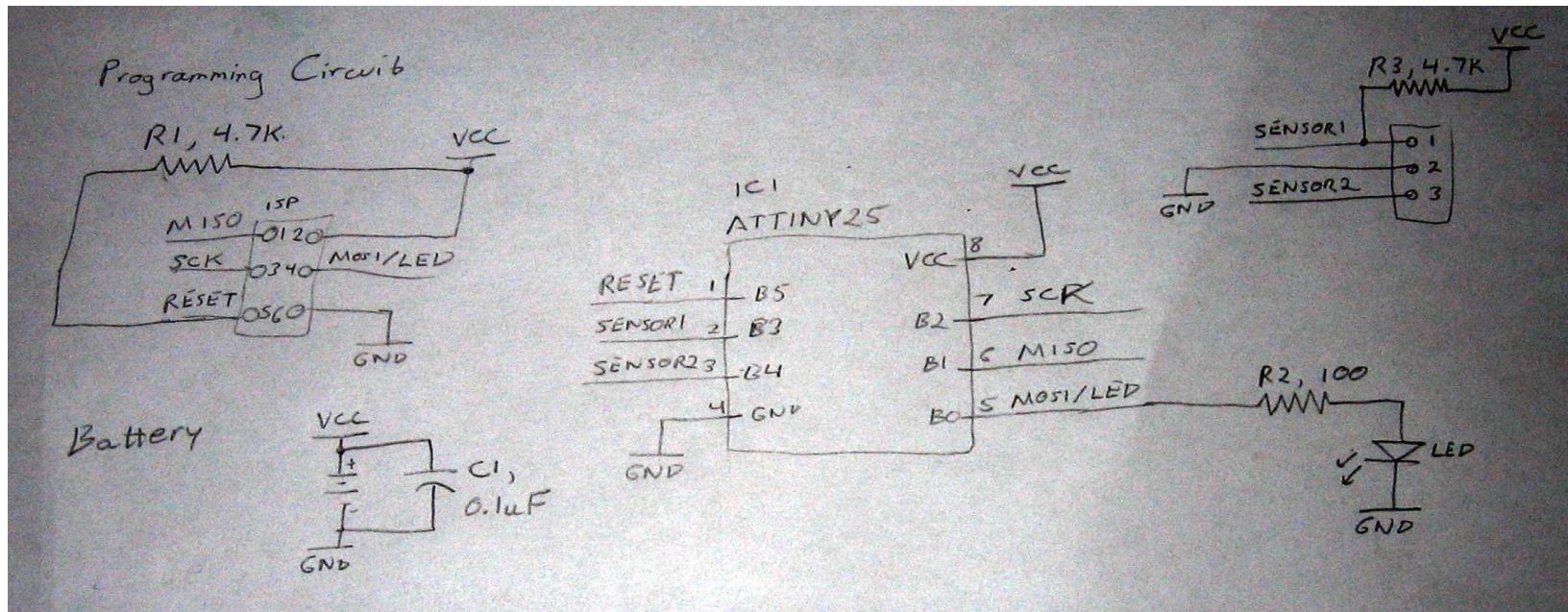
- Explaining *how* requires circuit diagrams

A photocell in a voltage divider is read by an ATTINY which outputs to an LED with a current-limiting resistor



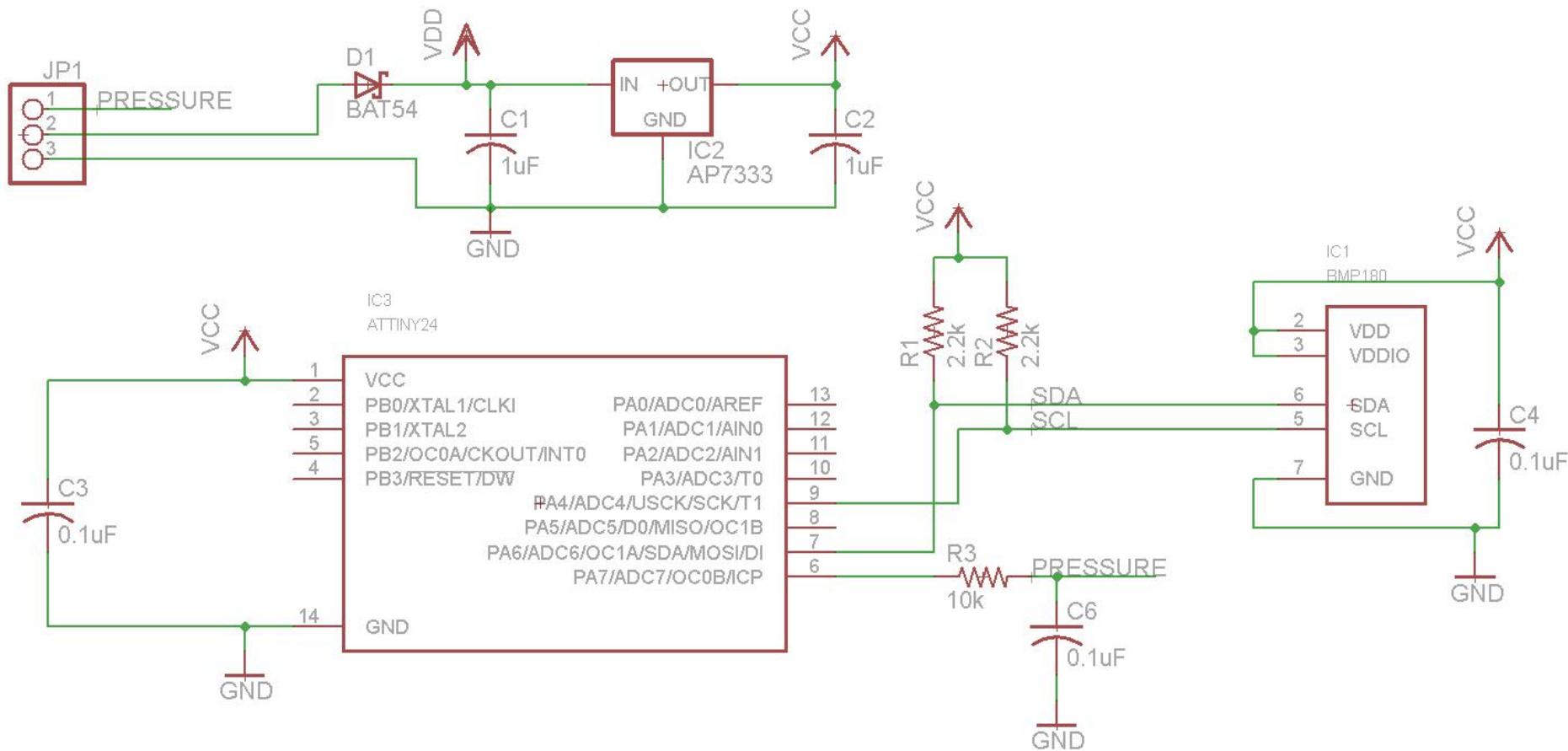
But... is this enough?

A complete schematic



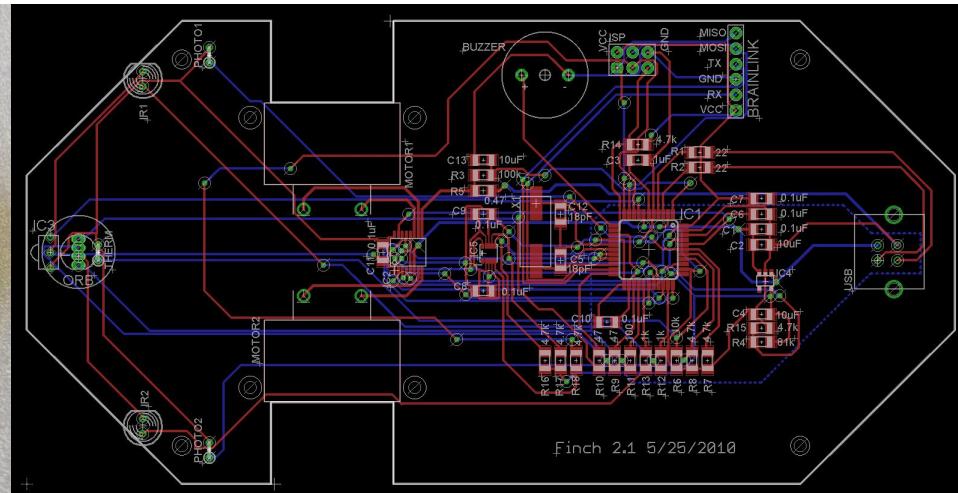
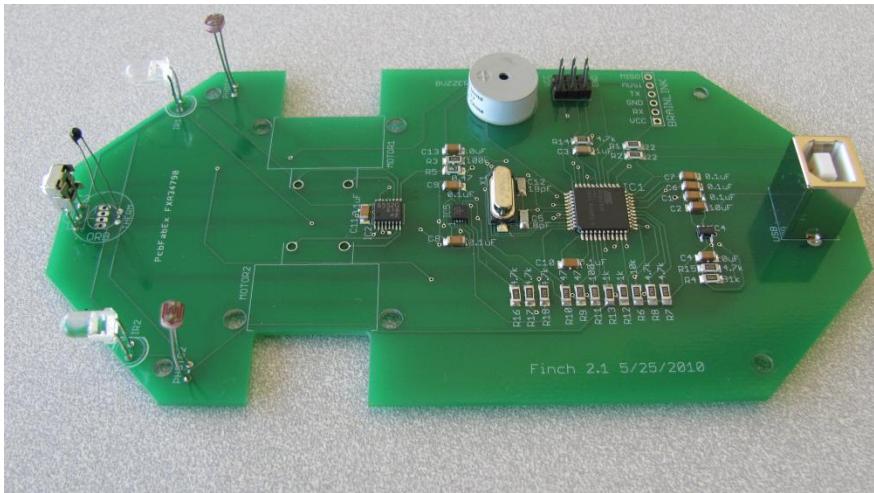
- Lots going on! A *complete schematic*.
- However, *layout is not apparent*

A Complete Schematic in Eagle



So I've Got my Schematic...

- **Time to make a “Layout”**
 - Scale representation of your PCB
- **Layers**
 - Copper in red and blue
 - Around holes it's in green
 - Designators in white
 - Holes marked with x's



Real World Layout Considerations

- **Design Rules**
- **Surface Mount and Through-hole**
- **Heat sinks**
- **Shape, mounting, and 2D representations of 3D parts**
- **Routing**

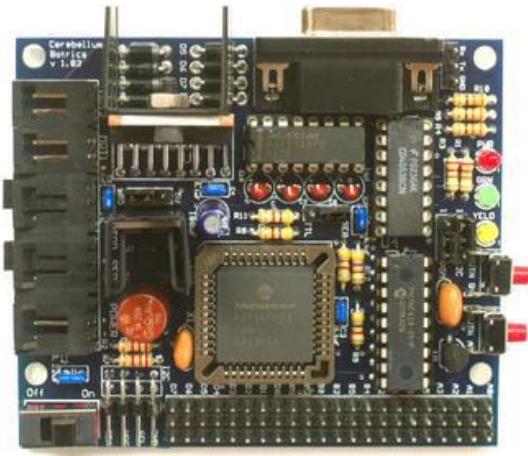
Design Rules

- Design Rules – “*Thou shalt nots*” for your circuit board
- Adjustable, but...they come from reality:
 - Advanced Circuits Capabilities
- Tell you things like:
 - How small traces can be
 - How small holes can be
 - Minimum distance between part, pad, trace, and the board’s edge
 - Minimum distance between traces
 - And much more!
- You must always address any violations and warnings flagged by the CAD software

Through-hole Vs. Surface Mount

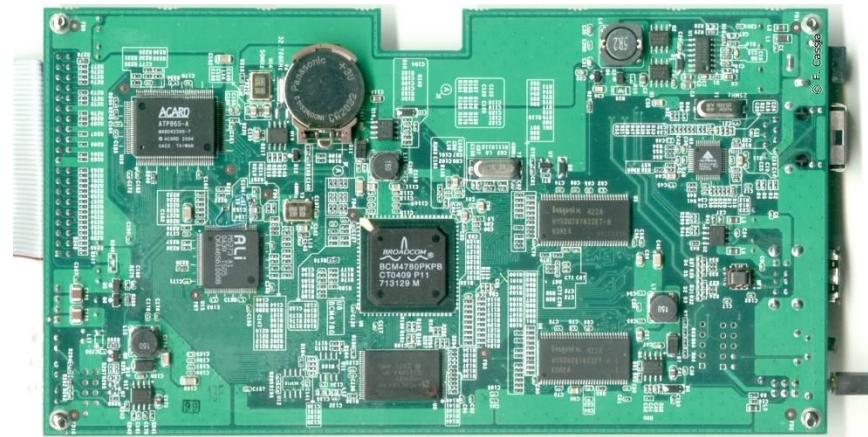
Through-Hole:

- Easy to solder
- Easier to fix circuits
- You don't lose components on the floor
- **Better for large connectors**



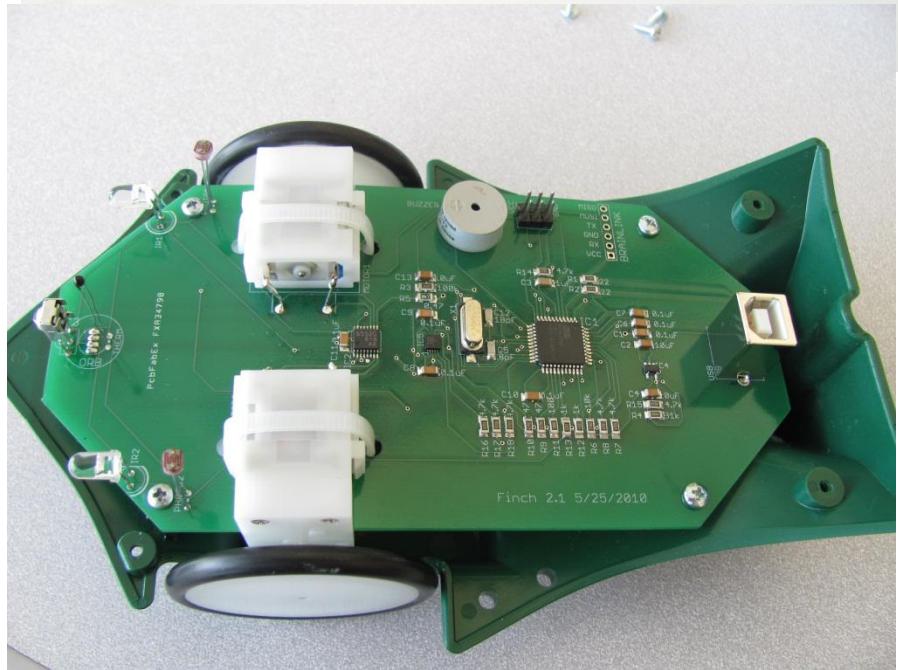
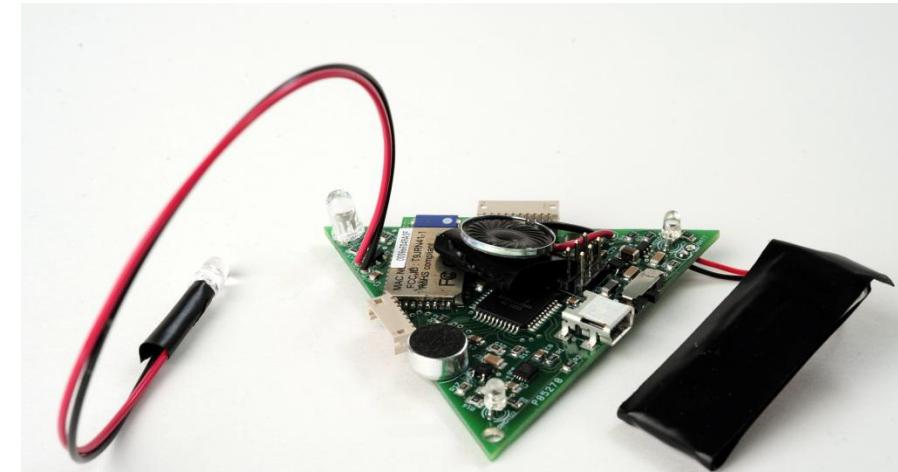
Surface Mount:

- Miniaturization
 - From small to ridiculous
- Easier Automated Assembly
- PCB Fab is easier – fewer holes to drill
- **Most cool parts are only Surface mount**



Shape, Mounting

- PCB does not need to be a rectangle
 - Not always a choice, though
 - Service used in this class requires rectangular shapes
- Make sure you allow for a way to mount the board
- Keep in mind: it's a 2D representation of a 3D part!



Heatsinking

- Some high power parts may require a heat sink
 - Often much bigger than part
 - Specified in datasheet
 - Make sure to factor size of heat sink into your layout
 - Location is also important
-
- **Insulate electrically !!!**



Routing

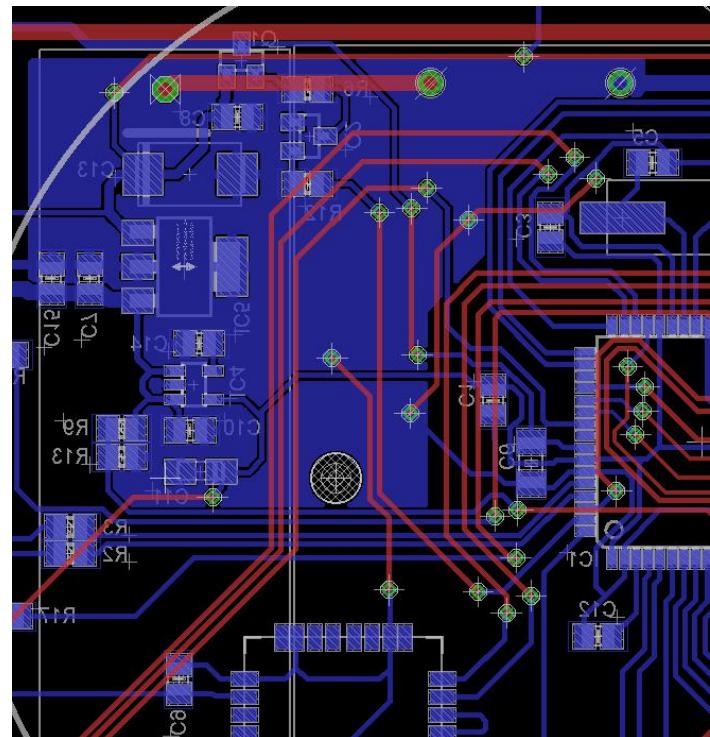
- **Definition:** *The process of making electrical connections between the different components by editing the physical (copper) representation of the nets created in your schematic*
- **Your “frenemy,” the autorouter**
 - Computers do the darnedest things
 - Fixing things may take as long as routing by hand
- **Routing by hand creates a much cleaner looking design**
 - However, it's invaluable for large projects!

Trace Widths and Power

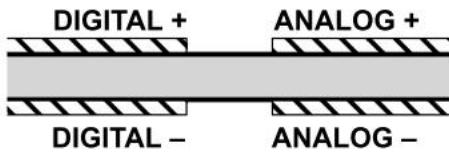
- All traces/wires have resistance
- Car jumper cables vs. Christmas lights
- Some traces need to be wider than others
 - Wider traces carry more current (necessary for driving high-current devices, like motors).
 - Thin trace carrying lots of current = FIRE
 - Wider traces have less noise (good for analog signals)
- Handy tool:
 - <http://www.4pcb.com/trace-width-calculator.html>
 - Understand issues with temperature

Planes

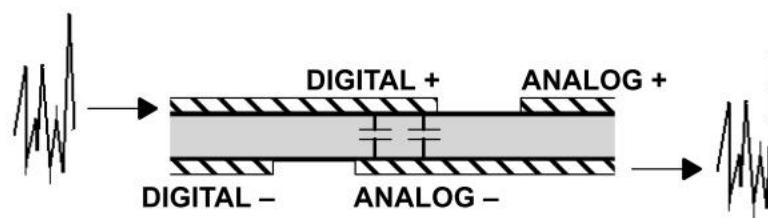
- Cover a large part of your board with copper connected to a net (typically ground)
- Used for:
 - Heat-sinking
 - Noise reduction
 - Simplify routing (one less net)



RIGHT



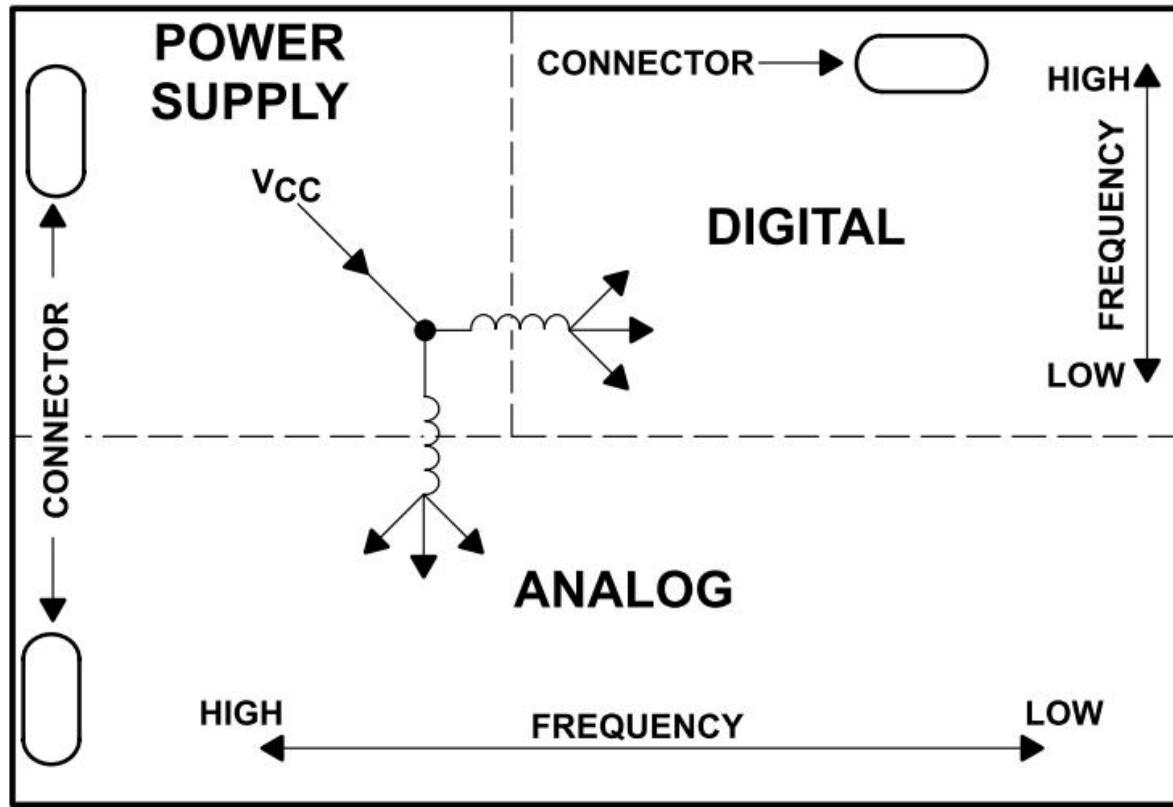
WRONG



Avoid coupling high-frequency digital noise into analog circuitry

Board Layout

- Careful placement prevents a lot of problems



- Keep grounds separate!!

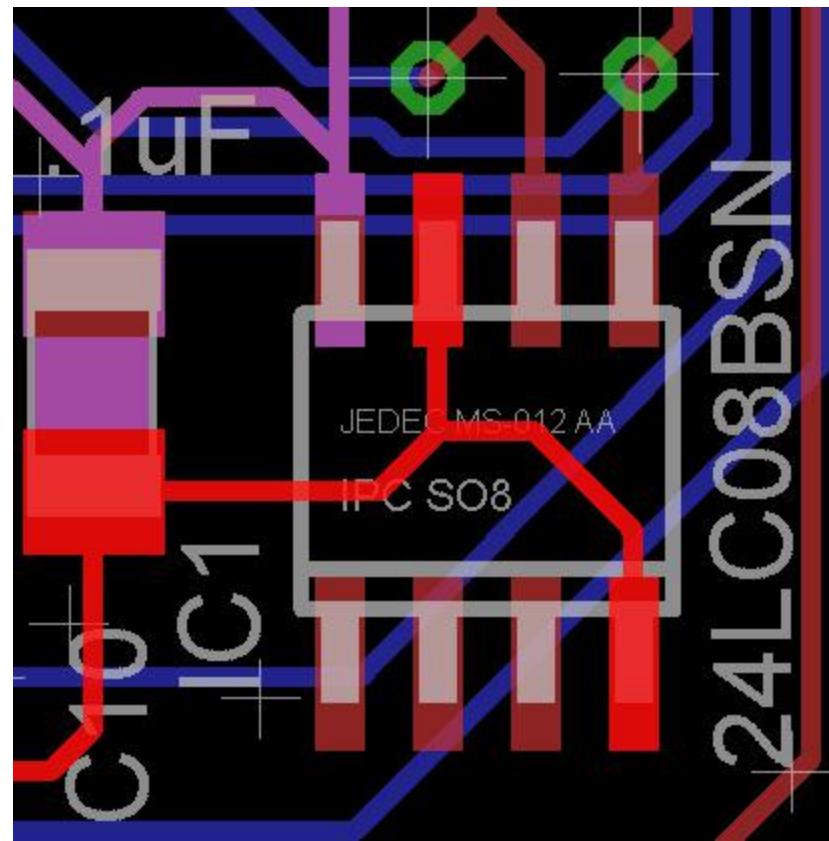
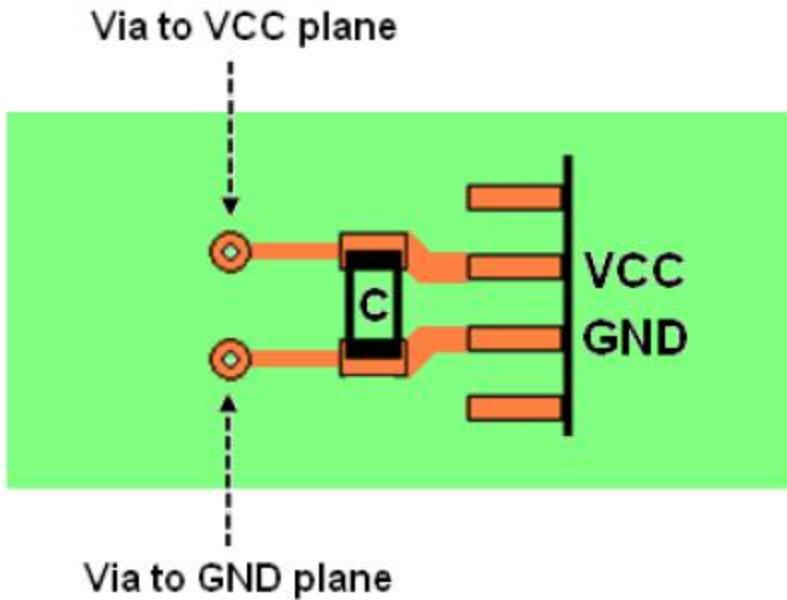
¹ But they must be common at a single, low-impedance point

Slight Detour: Decoupling Capacitor Placement

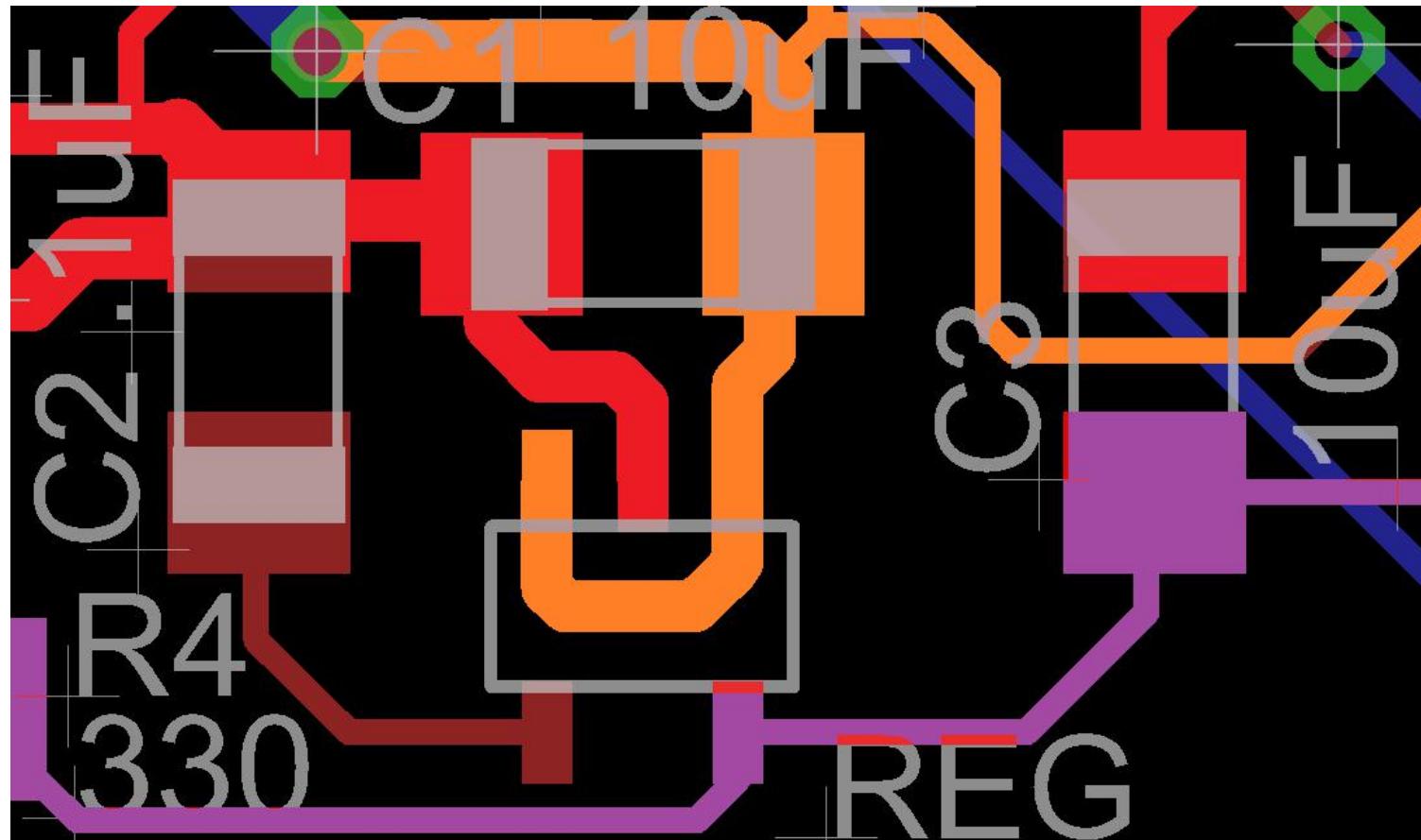
- **Short traces (less than 0.5")**
- **At least one per IC**
 - Usually one per pair of VCC/GND terminals on IC
- **Can be on underside if you want to save space**
- **Following slides – a few examples of good capacitor placement**

Good IC Decoupling

- VCC = PURPLE
- GND = RED



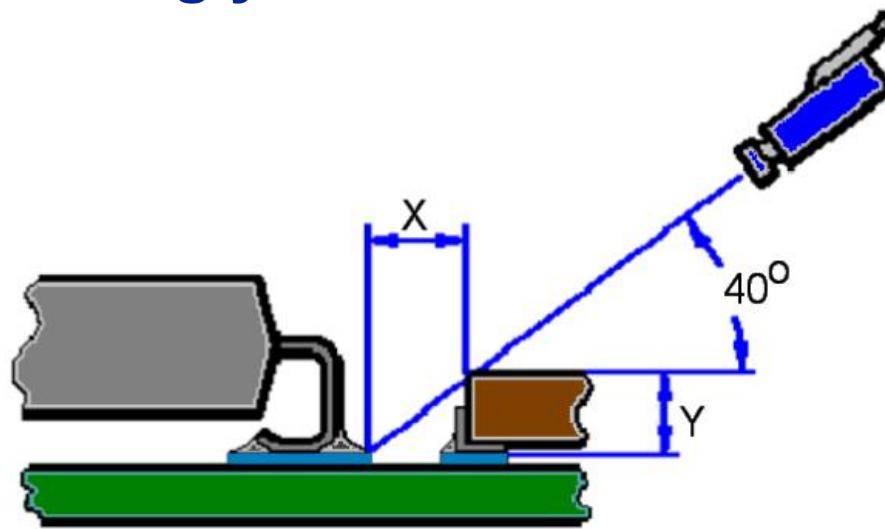
Good Input Capacitors for a Voltage Regulator



GND = Red, VDD = Orange, VCC = Purple

Design for Testing, Inspecting, and Assembling

- Test points
- Tooling pins
 - Precise registration with test fixture
 - Push fingers
- Clearances for inspection
- Simplify populating your board

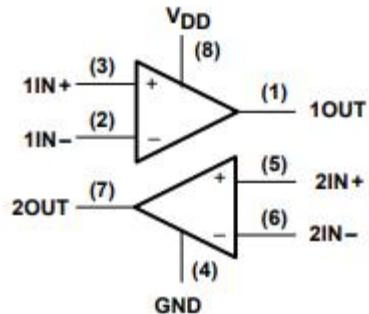


So where do parts come from?

- **Answer: Libraries!**
- **Every part is divided into three representations**
 - **Package**
 - The physical representation of the part
 - What you see in Layout view
 - **Symbol**
 - The logical representation of the part
 - What you see in Schematic View
 - **Device**
 - A place to tie the **package** to the **symbol**
 - Lets you re-use common packages on different parts
 - Lets you re-use common symbols on package variants

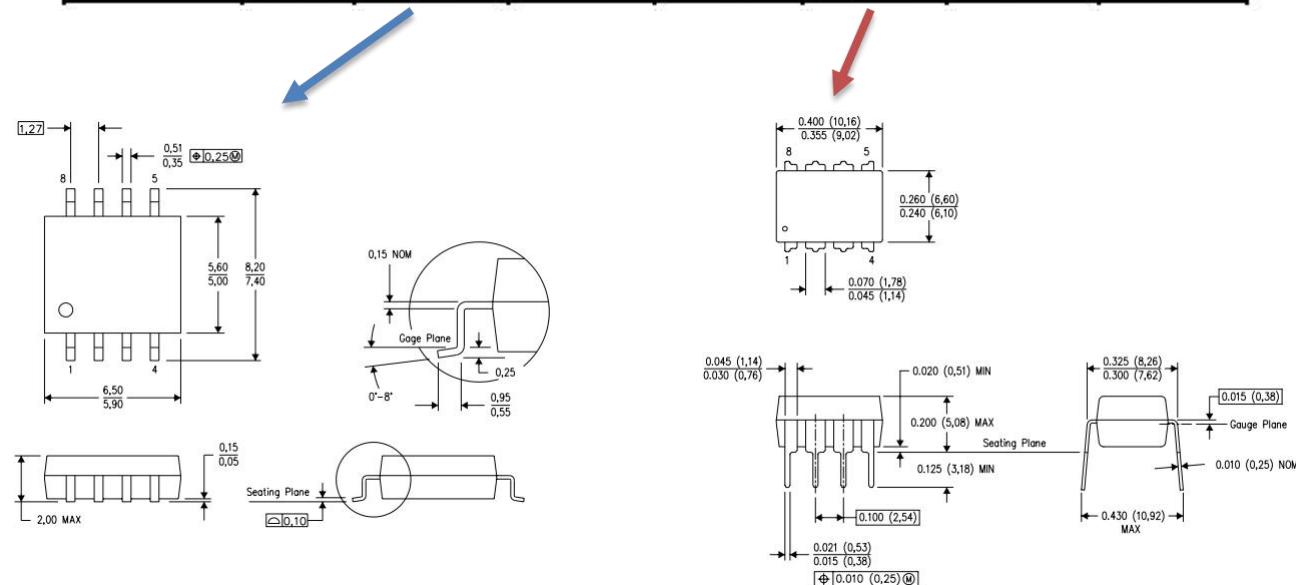
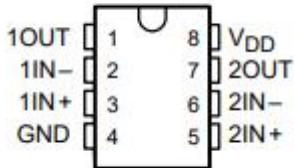
Device = Package + Symbol

TLC272, TLC272A, TLC272B, TLC272Y, TLC277 LinCMOS™ PRECISION DUAL OPERATIONAL AMPLIFIERS

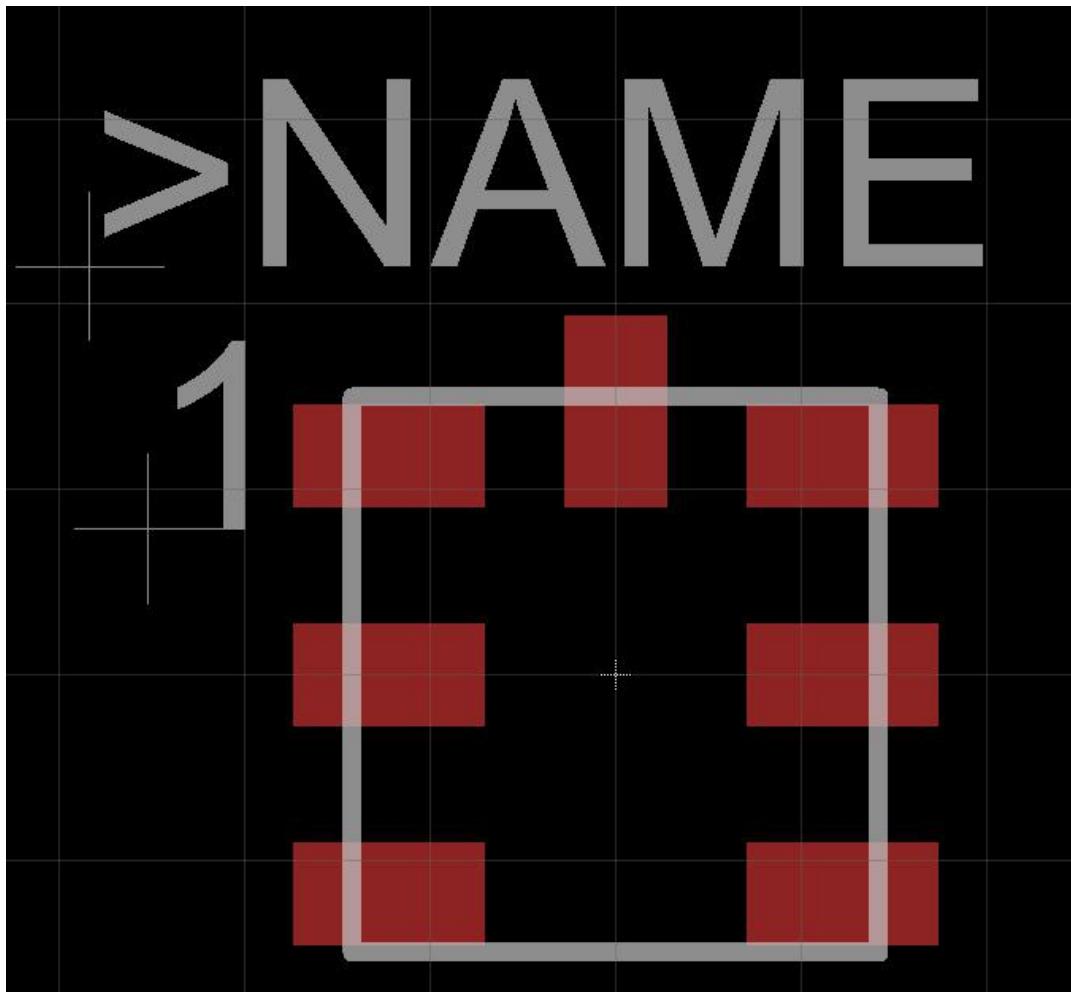


TA	V _{IOMax} AT 25°C	PACKAGED DEVICES					CHIP FORM (Y)
		SMALL OUTLINE (D)	CHIP CARRIER (FK)	CERAMIC DIP (JG)	PLASTIC DIP (P)	TSSOP (PW)	
0°C to 70°C	500 µV 2 mV 5 mV 10mV	TLC277CD TLC272BCD TLC272ACD TLC272CD	—	—	TLC277CP TLC272BCP TLC272ACP TLC272CP	—	—
−40°C to 85°C	500 µV 2 mV 5 mV 10 mV	TLC277ID TLC272BID TLC272AID TLC272ID	—	—	TLC277IP TLC272BIP TLC272AIP TLC272IP	—	—

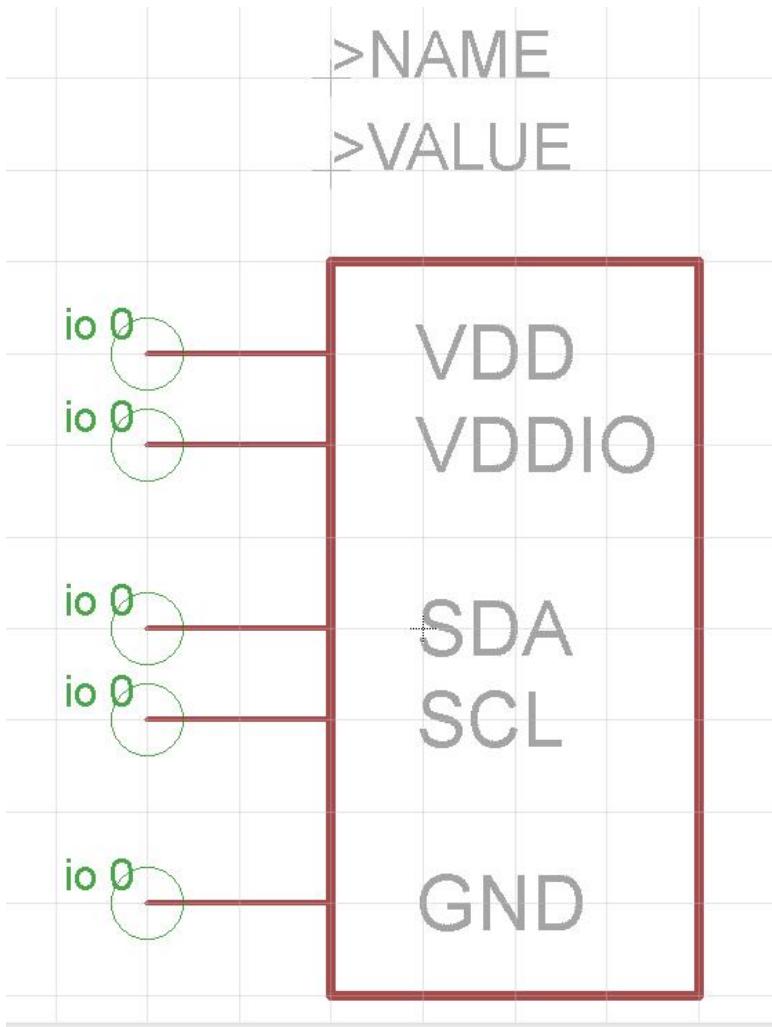
D, JG, P, OR PW PACKAGE
(TOP VIEW)



Sample Package View



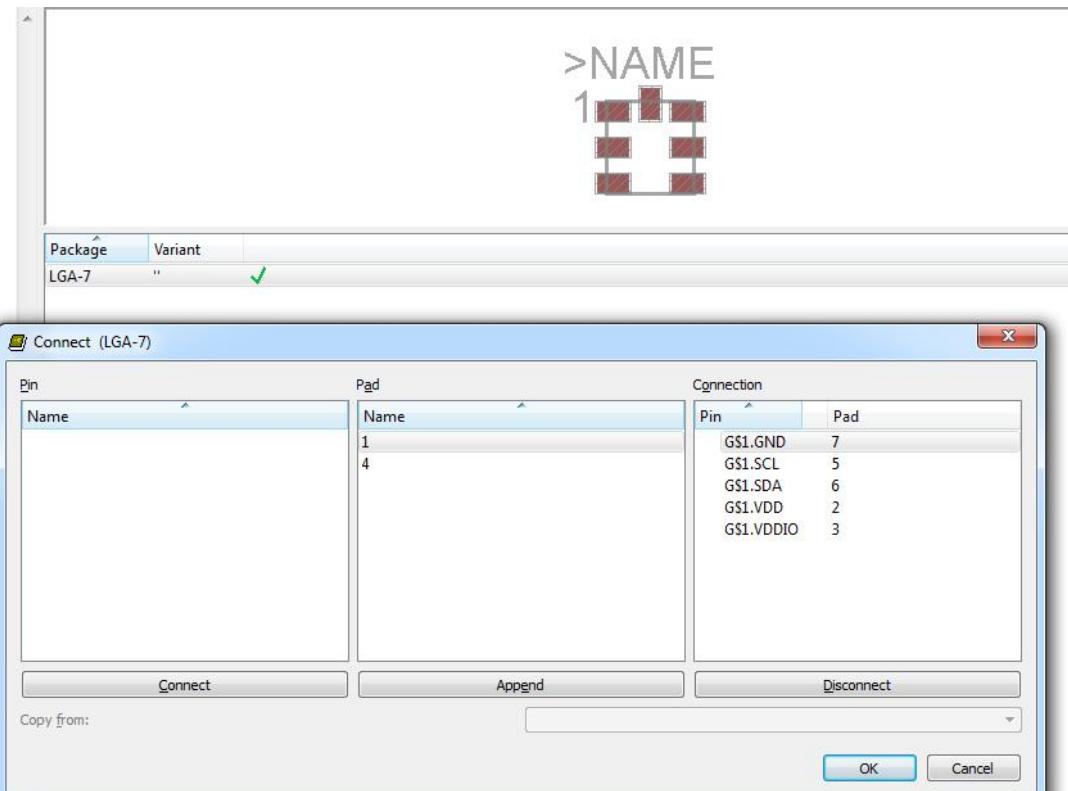
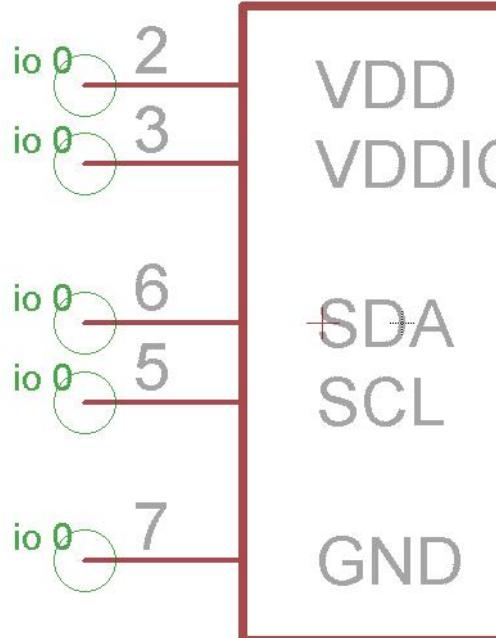
Sample Symbol View



Sample Device View

Add=next
Swap=0

G\$1
>VALUE



Always use meaningful names for devices, symbols, and packages

- Don't use the same name for everything!

Where do libraries come from?

- **EAGLE standard libraries**
 - Some are great, some are outdated
- **Online open-source libraries**
 - Contributed libraries on Eagle's site
 - Sparkfun, Adafruit, etc.
- **You!**
 - Complex or unusual parts are probably not in any library

Converting a System Diagram into an Electrical Schematic

Basic Implementation Guidelines

- Control
- Sensing/Actuation
- Power
- Interconnect

Implementing Control

- **Choosing a microcontroller**
 - AVR, PIC are popular choices
 - TI OMAP, Freescale, ARM7, ARM9...
 - Older architectures like 8051 or 16HC11
- **Also OK to plan on using a *microcontroller board* and interfacing to its connectors**
 - “Arduino shield”
 - Sensor/actuator boards (e.g. *L293 driver board*)
- **Others (higher degree of integration/capability)**
 - Raspberry PI, Beaglebone, Odroid, Jetson...

Implementing Control

- **Don't forget the baggage**
 - Usually specific programming infrastructure required ("toolchain")
 - A bunch of extra circuitry, specifically:
 - Required voltage regulation / decoupling
 - Programming connector (even if using a bootloader!)
- **For AVR consider availability of OSS avr-gcc compiler and avr-dude compiler.**
 - AVR Studio (windows only) also available free.
- **Arduino**
 - Uses AVR for the same reason
 - Also has bootloader / Processing interface for programming
 - If you like/need Arduino interface, consider making your own
 1. Download open source eagle files for your favorite Arduino version
 2. Modify design to add additional sensor/actuator interfaces to PCB
 3. Make PCB and re-release design files

Important Things to Remember on Control

- **Voltage Compatibility**
 - Modern ICs run at 3.3V or 1.8V, not 5V
 - If you need to hook up to a junky old sensor, may need level-shifting to prevent damage
- **Make sure to add debugging output**
 - Even a blinking LED helps iron out software kinks
 - A serial (or USB serial) port makes it even easier
- **Basic system testing – aim for a few simple milestones**
 - “Blink test” is a good first program (the “Hello World” of embedded systems)
 - Each subsystem should be able to be independently tested and verified, even if only in debugging mode

Sensing and Actuation

- **Sensing/Actuation lumps together subsystems that either:**
 - Measure the physical world and produce digital or analog values for a controller, or
 - Take digital or analog values from a controller and effect change on the physical world
- **Some sensors:**
 - Light sensors (photocells, cameras, photodiodes, etc.)
 - Temperature sensors (thermistors, thermocouples, etc.)
 - Contact sensors (buttons, limit switches, pressure pads, etc.)
 - Rangefinders (IR pairs, IR rangefinders, sonar, laser rangefinders, etc.)
- **Some actuators:**
 - Light sources (LEDs, lamps, neon, etc.)
 - Motion (Motors, servos, steppers, solenoids, piezo elements, etc.)
 - Sound (speakers, buzzers, piezo elements, etc.)

Support Circuitry

- **Most sensors/actuators require additional circuit elements to operate, such as:**
 - Discrete components (capacitors, resistors)
 - Additional, non-logic level voltage sources (especially for motors)
 - Level translation
 - Communications protocols (e.g. RS232/485 to TTL)
 - Also commonly for old 5V components interfacing to modern ICs
 - Electrical connectors to connect off-board components
- **Most devices explicitly tell you what support circuitry is needed in their *datasheets* (more on future lecture)**

Actuators Brief: Motion Control

- **Always use the least amount of control needed!**
 - Only need to drive one direction? MOSFET/relay
 - Bi-directionality requires H-bridge & support circuits
- **Aim for reasonable voltage/current**
 - 5V/500mA is easier than 50V/50A
 - 24V@2A is easier than 2V@24A [why?]
- **Many monolithic options available**
 - Driving 1-4 motors can be as simple as one IC, a few capacitors, and your connectors
 - L293 == L298 with integrated flyback diodes
 - Many MOSFET designs / ICs do not require flyback diodes
- **For high power (>10W), it may be easier to investigate hobby servos, off-board modules or motion control amps**

Implementing Power Systems

- All electromechanical devices require power to operate
- All modern electronics perform logical operations while generating heat
- When implementing a power system, understanding the *bounds* is essential:
 - Voltage ranges (min / max)
 - Current draw (quiescent / peak)
 - Storage capacity (mass / volume)
 - Runtime

Classifying Different Power Systems

Consider:

Voltage

Current

Capacity

Runtime

Different devices will have different requirements:

- Digital watch
- Wireless sensor node
- R/C Car
- R/C Quadrotor
- Computer performing video analysis
- Electric car

Implementing Power Systems

- **Regulation - switching, linear**
 - Low dropout
- **Banks of regulators**
- **Sizing loads for current at given voltages**
- **Sizing a battery for a given system**
- **Stability - capacitance, remote vs. local loads**
- **Recharging / power connections**
 - Power management systems

How Power Affects PCBs

- **May need multiple voltage sources**
 - Motors may need higher voltage than logic
 - Different logic may require different voltages
- **Current draw affects trace width and component size**
 - Big currents require big traces
 - Regulators for 100mA much smaller than for 2A

Voltage Regulation

- **Most systems designed to operate from a single source**
 - Wall (A/C) via AC/DC converter
 - Battery pack
 - Source voltage is usually optimized for largest power consuming subsystem (e.g. motors)
- **DC/DC converters used to create other subsystem voltages**
 - Logic voltage levels (frequently 1.8V, 3.3V, 5V)
 - Analog supplies ($\pm 5V$, $\pm 15V$)
 - Other (500V photoflash bank, 5kV neon ballast)
- **DC/DC converters also used to regulate voltages**
 - Stable voltages are essential for logic ICs
 - Helps isolate subsystems from each other

Voltage Regulation

- **Linear Regulators**

- Can only step-down voltages
- Dissipates excess as heat [voltage drop X subsystem current]
- Usually very clean signals
- Low cost and complexity
- Excellent for small voltage drops

- **Switching Regulators**

- Allows output voltage to be above and/or below input voltage
- Efficiencies typically 80-96%
- Higher cost
- Variable complexity – but Point of Load replacements available!
- Excellent for large voltage differences

Minimizing current can minimize power losses / regulator size

Linear vs. Switching Efficiency

- Desired Output Voltage: 5V

Input Voltage	Linear Efficiency	Switching Efficiency
5.5V	91%	80-90%
6V	83%	80-90%
12V	42%	80-90%
24V	21%	80-90%
3.3V	Not possible	80-90%

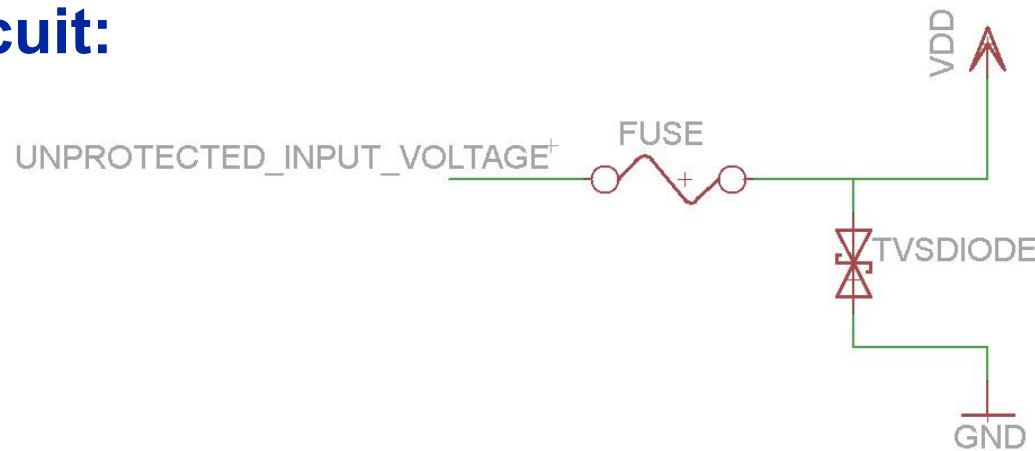
- Efficiency is not everything. 21% efficiency might be just fine if you're drawing 500 μ A.

Assembling a Power System

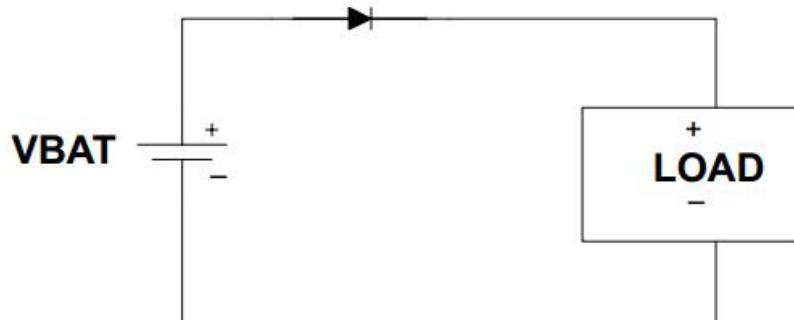
- **Determine source voltage and current requirements**
 - Optimize for primary power using subsystems
 - **Add current** to account for other subsystems *and conversion efficiencies*
- **Determine voltages and current limits of regulated voltages**
 - Primary power systems frequently run *unregulated*
 - May need several logic voltages or other supplies
- **Other useful power system features**
 - Switches (e.g. ON/OFF) are helpful
 - Fuses / breakers may be needed
 - Voltage and current monitoring
 - *Battery charge management*

Overvoltage and Reverse-voltage Protection

- It's 3 AM, and you just plugged your robot in backwards. Would you like to:
 - A: Change a fuse?
 - B: Put out a small fire, go through the stages of grief, and then solder together new PCBs, order new parts, and explain to your professor why your project is going to be a week late because nobody from your group remembered this slide
- Here's a circuit:

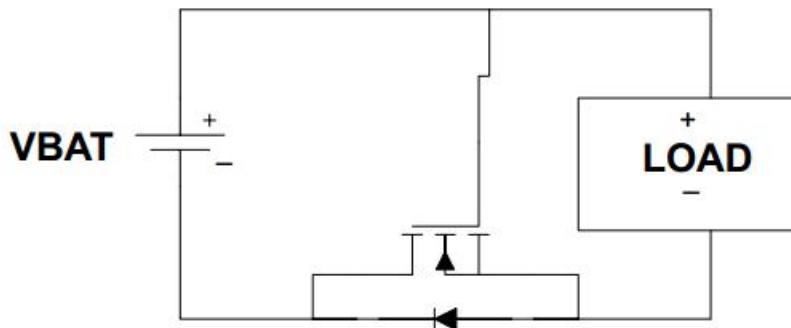


Reverse-Voltage Protection

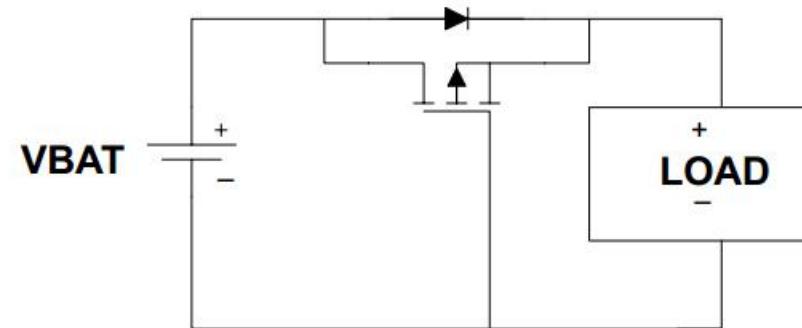


Diode in series with load

- Voltage drop
 - Batteries
 - Efficiency
- Use Schottky diode
 - Cost



NMOS FET in the ground
return path

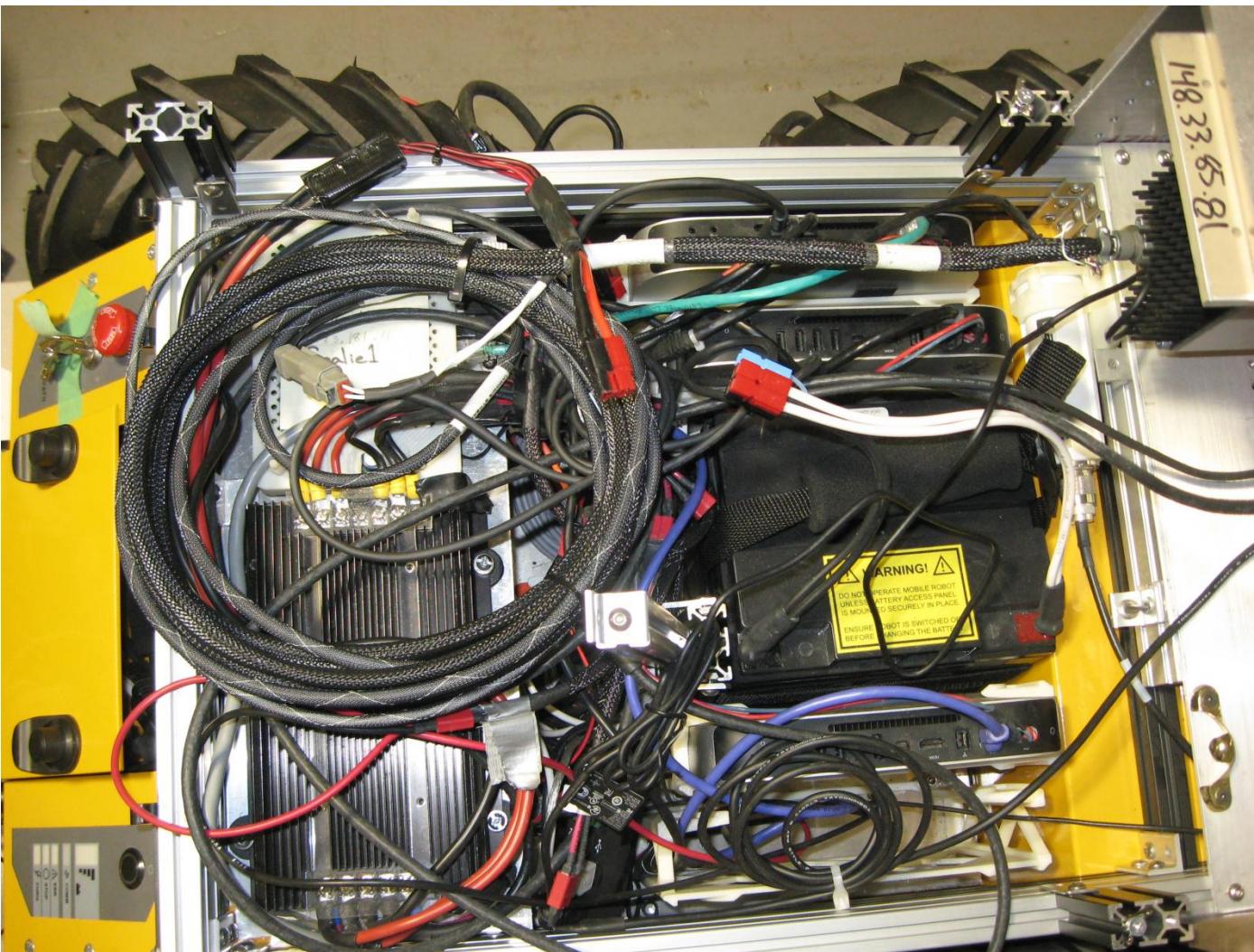


PMOS FET in the power path

Finally, Using *Interconnect* Appropriately

- **Wire (and PCB traces) should be sized appropriately for current loads**
 - [Trace Width Calculator](#) is an invaluable tool
 - Many wiring tables for various gauges show current capacity
 - Use stranded wire for connections!
- **Avoid analog effects on your digital designs**
 - Use short, thick traces for analog signals
 - Keep analog away from fast switching digital signals
 - Use ground planes or guard bands when appropriate
- **Use appropriate connectors**
 - Every connector is a potential point of failure
 - Observe current and connection cycle ratings
 - Use board-to-board when possible instead of board-wire-board

System Integration: Never Underestimate!



Teamwork and PCBs – Divvying efficiently

- **Schematic accumulation**
 - Everyone can contribute subcircuits
 - One person in charge of overall schematic / collating contributions
- **Part hunter**
 - At least one person should be searching for parts
 - Parts should be **available** and **captured into Eagle**
- **Verifier**
 - Dedicated to finding logical errors in schematics or layout
 - Goes through internet/team created libraries and checks parts
- **Layout and physical space planner**
 - Determine board size and shape
 - Board mounting hole placement
 - Determine where all connectors should be located
 - Ensures parts sticking off board won't interfere with chassis

Assignment Overview: Individual Assignment

- Due: Tuesday Nov. 7th
- Capture a hand-drawn schematic into Eagle, and make two layouts for it:
 - One all through hole
 - One all surface mount
- Create Eagle library versions of two parts from their datasheets
- Make sure to check out the two tutorials posted on Canvas, and send questions to us
- Please, make sure that you
 - Follow the file naming guidelines
 - Address any issues reported by ERC, DRC
 - *Unaddressed issues will reduce your grade*

Thank you!